



Click [here](#) for the 3D model.

### Dimensions

Chip Size	3640
L	9.3mm +/-0.6mm
W	10.2mm +/-0.4mm
T	2.5mm +/-0.20mm
B	1.27mm +/-0.4mm

### Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	250

### General Information

Series	KC-LINK Auto COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, High Voltage, Automotive Grade
Features	Ultra-Stable, Low Loss, Automotive Grade
RoHS	Yes
Termination	Tin
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Component Weight	1.06 g
Shelf Life	78 Weeks
MSL	1

### Specifications

Capacitance	0.18 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	1%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+150°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	5.5556 GOhms